2.5V / 3.3V Differential 4:1 Mux Input to 1:2 LVPECL Clock/Data Fanout / Translator

Multi-Level Inputs w/ Internal Termination

The NB7L572 is a high performance differential 4:1 Clock/Data input multiplexer and a 1:2 LVPECL Clock/Data fanout buffer. The INx/INx inputs includes internal 50 Ω termination resistors and will accept differential LVPECL, CML, or LVDS logic levels. The NB7L572 incorporates a pair of Select pins that will choose one of four differential inputs and will produce two identical LVPECL output copies of Clock or Data operating up to 7 GHz or 10 Gb/s, respectively. As such, NB7L572 is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The NB7L572 INx/ $\overline{\text{INx}}$ inputs, outputs and core logic are powered by a 2.5 V ± 5% V or 3.3 V ± 10% power supply. The two differential LVPECL outputs will swing 750 mV when externally terminated with a 50 Ω resistor to V_{CC} – 2 V, and are optimized for low skew and minimal jitter.

The NB7L572 is offered in a low profile 5x5 mm 32-pin QFN Pb-free package. Application notes, models, and support documentation are available at www.onsemi.com.

The NB7L572 is a member of the GigaComm[™] family of high performance clock products.

Features

- Input Data Rate > 10.7 Gb/s Typical
- Data Dependent Jitter < 15 ps
- Maximum Input Clock Frequency > 7 GHz Typical
- Random Clock Jitter < 0.8 ps RMS
- Low Skew 1:2 LVPECL Outputs, < 15 ps max
- 4:1 Multi-Level Mux Inputs, Accepts LVPECL, CML LVDS
- 150 ps Typical Propagation Delay
- 60 ps Typical Rise and Fall Times
- Differential LVPECL Outputs, 750 mV Peak-to-Peak, Typical
- Operating Range: $V_{CC} = 2.375$ V to 3.6 V
- Internal 50 Ω Input Termination Resistors
- V_{REFAC} Reference Output
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices

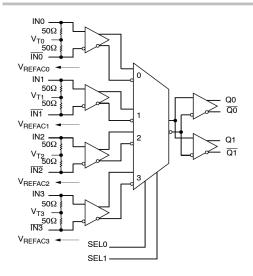


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Application Note AND8002/D.



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

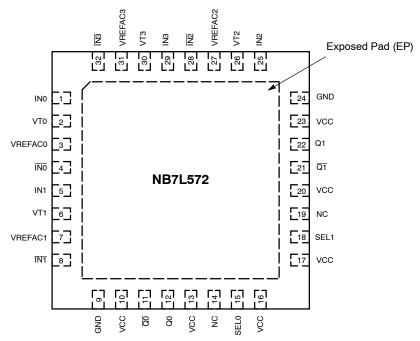


Figure 1. Pinout Configuration (Top View)

Table 1. INPUT SELECT FUNCTION TABLE

SEL1*	SEL0*	Clock / Data Input Selected	
0	0	IN0 Input Selected	
0	1	IN1 Input Selected	
1	0	IN2 Input Selected	
1	1	IN3 Input Selected	

*Defaults HIGH when left open.

Table 2. PIN DESCRIPTION

Pin	Name	I/O	Description
1, 4 5, 8 25, 28 29, 32	IN0, <u>IN0</u> IN1, <u>IN1</u> IN2, <u>IN2</u> IN3, IN3	LVPECL, CML, LVDS Input	Non-inverted, Inverted, Differential Clock or Data Inputs.
2, 6 26, 30	VT0, VT1 VT2, VT3		Internal 100 Ω Center-tapped Termination Pin for INx / $\overline{\text{INx}}$
15 18	SEL0 SEL1	LVTTL/LVCMOS Input	Input Select pins, default HIGH when left open through a 28k– Ω pull–up resistor. Input logic threshold is V _{CC} /2. See Select Function, Table 1.
14, 19	NC	-	No Connect
10, 13, 16 17, 20, 23	VCC	-	Positive Supply Voltage. All V_{CC} pins must be connected to the positive power supply for correct DC and AC operation.
11, 12 21, 22	<u>Q0</u> , Q0 <u>Q1</u> , Q1	LVPECL Output	Inverted, Non-inverted Differential Outputs.
9, 24	GND		Negative Supply Voltage, connected to Ground
3 7 27 31	VREFAC0 VREFAC1 VREFAC2 VREFAC3	-	Output Voltage Reference for Capacitor-Coupled Inputs
-	EP	-	The Exposed Pad (EP) on the QFN–32 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat–sinking conduit. The pad is electrically connected to the die, and must be electrically connected to GND.

In the differential configuration when the input termination pins (VT0, VT1, VT2, VT3) are connected to a common termination voltage or left open, and if no signal is applied on INx / INx input, then the device will be susceptible to self-oscillation.
 All VCC, and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characterist	Value	
ESD Protection	Human Body Model Machine Model	> 4 kV > 150 V
Input Pullup Resistor (R _{PU})	28 kΩ	
Moisture Sensitivity (Note 3)	Level 1	
Flammability Rating Oxygen Index: 2	UL 94 V–0 @ 0.125 in	
Transistor Count	205	
Meets or exceeds JEDEC Spec EIA/		

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		-0.5 to +4.0	V
V _{IN}	Positive Input Voltage	GND = 0 V		–0.5 to V _{CC} +0.5	V
V _{INPP}	Differential Input Voltage IN – ĪN			1.89	V
l _{out}	LVPECL Output Current	Continuous Surge		50 100	mA mA
I _{IN}	Input Current Through RT (50 Ω Resistor)			±40	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 lfpm 500 lfpm	QFN-32 QFN-32	31 27	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case) (Note 4)		QFN-32	12	°C/W
T _{sol}	Wave Solder	\leq 20 sec		265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

Table 5. DC CHARACTERISTICS POSITIVE LVPECL OUTPUT V_{CC} = 2.375 V to 3.6 V, GND = 0 V, TA = -40°C to +85°C (Nata C)

(Note 6)						
Symbol	Characteristic		Min	Тур	Max	Unit
POWER	SUPPLY				•	
V _{CC}	Power Supply Voltage	$\begin{array}{l} V_{CC} = 2.5 V \\ V_{CC} = 3.3 \ V \end{array}$	2.375 3.0	2.5 3.3	2.625 3.6	V
I _{CC}	Power Supply Current for V _{CC} (Inputs and Outputs Open)			90	110	mA
LVPECL	OUTPUTS					
V _{OH}	Output HIGH Voltage (Note 6)	V _{CC} = 2.5 V V _{CC} = 3.3 V	V _{CC} – 1145 1355 2155		V _{CC} – 825 1675 2475	mV
V _{OL}	Output LOW Voltage (Note 6)	V _{CC} = 2.5 V V _{CC} = 3.3 V	V _{CC} - 2000 500 1300		V _{CC} – 1500 1000 1800	mV
DIFFERE	ENTIAL CLOCK INPUTS DRIVEN SINGLE-ENDED (Figures	s 4 & 6) (Note 7)				
V _{IH}	Single-Ended Input HIGH Voltage		V _{th} + 100		V _{CC}	mV
V _{IL}	Single-Ended Input LOW Voltage		GND		$V_{th} - 100$	mV
V _{th}	Input Threshold Reference Voltage Range (Note 8)		1100		V _{CC} - 100	mV
V _{ISE}	Single-Ended Input Voltage (VIH - VIL)	200		1200	mV	
VREFAC						
V _{REF-AC}	AC Output Reference Voltage (100 μA Load)				V _{CC} - 1000	mV
DIFFERE	ENTIAL INPUTS DRIVEN DIFFERENTIALLY (Figures 5 & 7)	(Note 9)				
V _{IHD}	Differential Input HIGH Voltage (IN, IN)		1200		V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage (IN, IN)		0		V _{IHD} - 100	mV
V _{ID}	Differential Input Voltage (IN, \overline{IN}) (V _{IHD} – V _{ILD})		100		1200	mV
V _{CMR}	Input Common Mode Range (Differential Configuration, Note 10) (Figure 8)		1150		V _{CC} - 50	mV
I _{IH}	Input HIGH Current IN/IN (VT IN/VT IN Open)		-150		150	μA
IIL	Input LOW Current IN/IN (VT IN/VT IN Open)		-150		150	μA
CONTRO	DL INPUT (SELx Pin)					
V _{IH}	Input HIGH Voltage for Control Pin		2.0		V _{CC}	V
V _{IL}	Input LOW Voltage for Control Pin		GND		0.8	V
I _{IH}	Input HIGH Current				40	μA
I _{IL}	Input LOW Current	-215		0	μA	
TERMIN	ATION RESISTORS					
R _{TIN}	Internal Input Termination Resistor (Measured from INx to	VTx)	40	50	60	Ω
	•					

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and Output parameters vary 1:1 with V_{CC}. 6. LVPECL outputs loaded with 50 Ω to V_{CC} – 2V for proper operation.

7. Vth, V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.

8. Vth is applied to the complementary input when operating in single-ended mode.

 V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously.
 V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the most positive side of the differential input signal.

Symbol	Characteristic			Тур	Max	Unit
f _{MAX}	Maximum Input Clock Frequency $V_{OUT} \ge 400$	mV	7			GHz
f _{DATAMAX}	Maximum Operating Data Rate NRZ, (PRBS23)	10.7			Gbps
V _{OUTPP}	$ Output \ \text{Voltage Amplitude (@V_{\text{INPPmin}}) (Figure 2 \& 9) } \qquad \begin{array}{l} f_{\text{in}} \leq 5 \ \text{GHz} \\ f_{\text{in}} \leq 7 \ \text{GHz} \end{array} $		550	750		mV
t _{PLH} , t _{PHL}	Propagation Delay to Differential Outputs Measured at Differential Cross-Point	@ 1 GHz INx/INx to Qx/Qx (Figure 9) @ 50 MHz SELx to Qx (Figure 10)	215 100		390 500	ps
t _{PD Tempco}	Differential Propagation Delay Temperature Coefficient			115		fs/∘C
t _{skew}	Output – Output skew (within device) (Note 13) Device – Device skew (tpd max – tpd min)			0	15 100	ps
t _{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%)			50	55	%
^t JITTER	$ \begin{array}{ll} \mbox{Additive Random Clock Jitter, RJ(RMS) (Note 14)} & f_{in} = 5.0 \mbox{ GHz} \\ f_{in} = 7.0 \mbox{ GHz} \\ \mbox{Data Dependent Jitter, DDJ (Note 15)} & 6.5 \mbox{ Gbps} \\ & 10 \mbox{ Gbps} \end{array} $			0.5 0.5	0.8 0.8 15 15	ps rms ps pk-pk
V _{INPP}	Input Voltage Swing (Differential Configuration) (Note 16)				1200	mV
t _{r,} , t _f	Output Rise/Fall Times @ 1 GHz; (20% - 80%)	, $V_{IN} = 800 \text{ mV Q}, \overline{Q}$	35	60	110	ps

Table 6. AC CHARACTERISTICS	5 V _{CC} = 2.375 V to 3.6 V, GND = 0 V, TA = −40°C to +85°C (N	Note 11)
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NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

 Measured using a 100 mVpk-pk source, 50% duty cycle clock source. All output loading with external 50 Ω to V_{CC} – 2 V. Input edge rates 40 ps (20% – 80%).

12. Output voltage swing is a single-ended measurement operating in differential mode.

13. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the cross-point of the outputs.

14. Additive RMS jitter with 50% duty cycle clock signal.

15. Additive Peak-to-Peak data dependent jitter with input NRZ data at K28.5.

16. Input voltage swing is a single-ended measurement operating in differential mode.

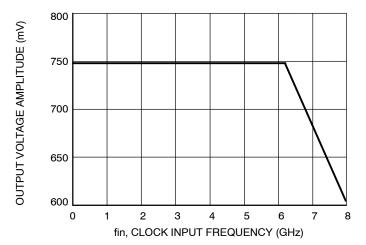


Figure 2. CLOCK Output Voltage Amplitude (V_{OUTPP}) / RMS Jitter vs. Input Frequency (f_{in}) at Ambient Temperature (typical)

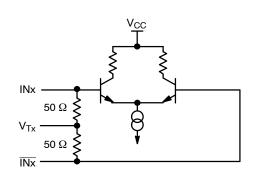
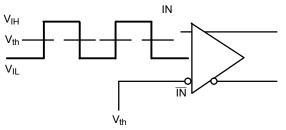
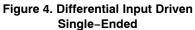
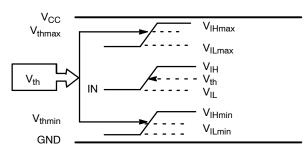


Figure 3. Input Structure









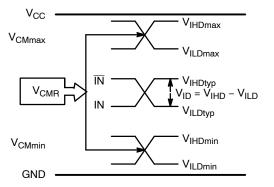


Figure 8. V_{CMR} Diagram

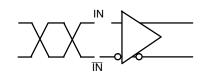
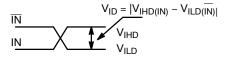
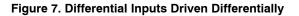
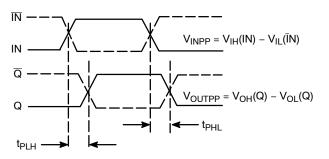


Figure 5. Differential Inputs Driven Differentially









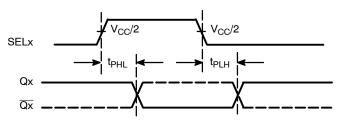


Figure 10. SELx to Qx Timing Diagram

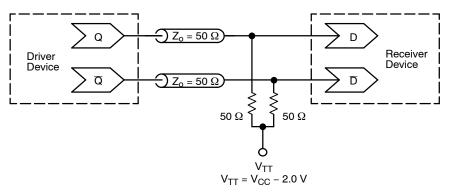
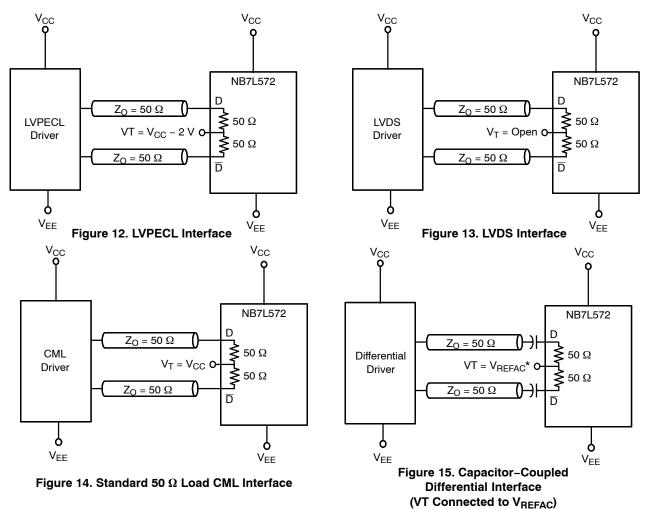


Figure 11. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)



*V_{REFAC} bypassed to ground with a 0.01 μ F capacitor

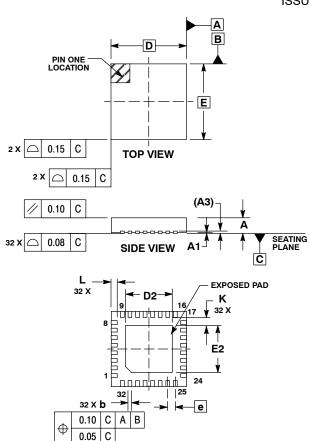
ORDERING INFORMATION

Device	Package	Shipping [†]
NB7L572MNG	QFN32 (Pb-Free)	79 Units / Rail
NB7L572MNR4G	QFN32 (Pb-Free)	1000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

QFN32 5x5, 0.5P CASE 488AM-01 **ISSUE O**



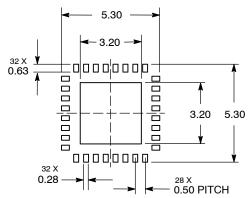
BOTTOM VIEW

NOTES:

- UTES:
 DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM TERMINAL
 CONDUMENTATION TO THE EXPOSED
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	0.800	0.900	1.000			
A1	0.000	0.025	0.050			
A3	0.	0.200 REF				
b	0.180	0.250	0.300			
D	5.	00 BSC				
D2	2.950	3.100	3.250			
Е	5.	.00 BSC				
E2	2.950	3.100	3.250			
е	0.500 BSC					
К	0.200					
L	0.300	0.400	0.500			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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